



### DFLZ5V1 - DFLZ39

### 1.0W SURFACE MOUNT POWER ZENER DIODE POWERDI® 123

### **Features**

- 1W Power Dissipation on FR-4 PCB
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- Patented Interlocking Clip Design for High Surge Capacity, US Patent #7,095,113

### **Mechanical Data**

- Case: POWERDI123
- Case Material: Molded Plastic, "Green" Molding Compound;
   UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: Cathode Band
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.01 grams (Approximate)



Top View

## Ordering Information (Note 4)

Part Number	Case	Packaging
(Type Number)-7*	POWERDI®123	3,000/Tape & Reel

<sup>\*</sup> Add "-7" to the appropriate type number in Electrical Characteristics Table. Example: 6.2V Zener = DFLZ6V2-7

Notes:

- 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
- 2. See http://www.diodes.com for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

# **Marking Information**



Fxx = Product Type Marking Code (See Electrical Characteristics Table) YM = Date Code Marking Y = Year (ex: A = 2013)

M = Month (ex: 9 = September)

### Date Code Key

Year	2007	200	08 2	009	2010	20	11	2012	2013	2014	2015	2016	2017	2018
Code	J	V	′	W	Χ	Υ	1	Z	Α	В	С	D	Е	F
Mon	th	Jan	Feb	M	ar A	pr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Cod	е	1	2	3	3	4	5	6	7	8	9	0	N	D



# **Maximum Ratings** (@ $T_A = +25$ °C, unless otherwise specified.)

	Characteristic	Symbol	Value	Unit
Forward Voltage	@ I <sub>F</sub> = 200mA	VF	1.2	V

# **Thermal Characteristics**

Characteristic	Symbol	Тур	Value	Unit
Power Dissipation (Note 5)	$P_{D}$	_	1.0	W
Thermal Resistance Junction to Ambient Air (Note 5)	$R_{\theta JA}$	110	_	°C/W
Thermal Resistance Junction to Soldering Point (Note 6)	$R_{\theta JS}$	_	9	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	_	-55 to +150	°C

# Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Type Number	Marking Codes				Zener Impedance		Maximum Reverse Current (Note 7)		Temperature Coefficient @ I <sub>ZTC</sub>		
Number	Codes	V <sub>Z</sub> @ I <sub>ZT</sub>		I <sub>ZT</sub>	Z <sub>ZT</sub> (	@ I <sub>ZT</sub>	I <sub>R</sub> @ V <sub>R</sub>		%/°C		
		Nom (V)	Min (V)	Max (V)	mA	Typ (Ω)	Max (Ω)	μΑ	٧	Min	Max
DFLZ5V1	FHK	5.1	4.8	5.4	100	2	6	2.5	1	-0.08	-0.2
DFLZ5V6	FHL	5.6	5.2	6.0	100	1	4	10	2	-0.04	0.04
DFLZ6V2	FHN	6.2	5.8	6.6	100	1	3	5	2	-0.01	0.06
DFLZ6V8	FHO	6.8	6.4	7.2	100	1	3	5	3	0	0.07
DFLZ7V5	FHQ	7.5	7.0	7.9	100	1	2	5	3	0	0.07
DFLZ8V2	FHR	8.2	7.7	8.7	100	1	2	5	3	0.03	0.08
DFLZ9V1	FHT	9.1	8.5	9.6	50	1	4	5	5	0.03	0.08
DFLZ10	FHU	10	9.4	10.6	50	1	4	5	7.5	0.05	0.09
DFLZ11	FHV	11	10.4	11.6	50	1	7	4	8.2	0.05	0.10
DFLZ12	FHW	12	11.4	12.7	50	1	7	3	9.1	0.05	0.10
DFLZ13	FHX	13	12.4	14.1	50	1	10	2	10	0.05	0.10
DFLZ15	FHZ	15	13.8	15.6	50	1	10	1	11	0.05	0.10
DFLZ16	FJA	16	15.3	17.1	25	1	15	1	12	0.06	0.11
DFLZ18	FJF	18	16.8	19.1	25	2	15	1	13	0.06	0.11
DFLZ20	FJG	20	18.8	21.2	25	3	15	1	15	0.06	0.11
DFLZ22	FJK	22	20.8	23.3	25	3	15	1	16	0.06	0.11
DFLZ24	FJL	24	22.8	25.6	25	2	15	1	18	0.06	0.11
DFLZ27	FJN	27	25.1	28.9	25	3	15	1	20	0.06	0.11
DFLZ30	FJQ	30	28	32	25	8	15	1	22	0.06	0.11
DFLZ33	FJR	33	31	35	25	5	15	1	24	0.06	0.11
DFLZ36	FJS	36	34	38	10	5	40	1	27	0.06	0.11
DFLZ39	FJT	39	37	41	10	5	40	1	30	0.06	0.11

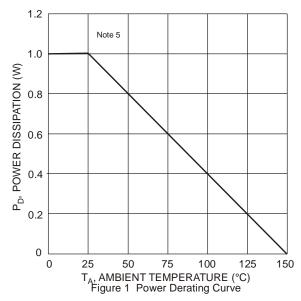
Notes:

<sup>5.</sup> Device mounted on 1" x 1", FR-4 PCB; 2 oz. Cu pad layout as shown on Diodes Inc. suggested pad layout document AP02001.pdf at http://www.diodes.com.

<sup>6.</sup> Theoretical R $\theta$ JS calculated from the top center of the die straight down to the PCB/cathode tab solder junction.

<sup>7.</sup> Short duration pulse test used to minimize self-heating effect.





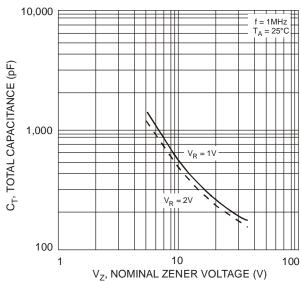
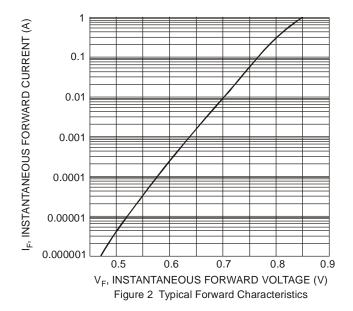


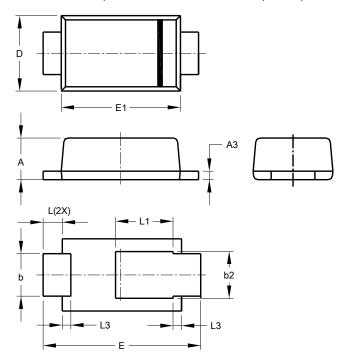
Figure 3 Typical Total Capacitance vs. Nominal Zener Voltage





# **Package Outline Dimensions**

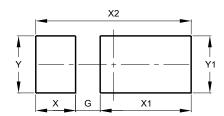
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



POWERDI <sup>®</sup> 123							
Dim	Min	Max	Тур				
Α	0.93	1.00	0.98				
А3	0.15	0.25	0.20				
b	0.85	1.25	1.00				
b2	1.025	1.125	1.10				
D	1.63	1.93	1.78				
E	3.50	3.90	3.70				
E1	2.60	3.00	2.80				
L	0.40	0.50	0.45				
L1	1.25	1.40	1.35				
L3	0.125	0.275	0.20				
All Dimensions in mm							

# **Suggested Pad Layout**

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value		
פווטופוופוווט	(in mm)		
G	0.65		
Х	1.05		
X1	2.40		
X2	4.10		
Y	1.50		
Y1	1.50		



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